## DISCRETE SEMICONDUCTORS

## DATA SHEET

# **BGY887B**CATV amplifier module

Product specification Supersedes data of February 1995 1997 Apr 15



## **CATV** amplifier module

**BGY887B** 

#### **FEATURES**

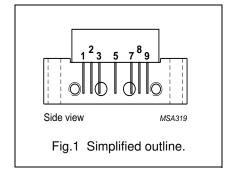
- · Excellent linearity
- · Extremely low noise
- High gain
- Excellent return loss properties.

## **APPLICATIONS**

 Single-module line extender in CATV systems operating in the 40 to 860 MHz frequency range.

#### **PINNING - SOT115J**

PIN	DESCRIPTION	
1	input	
2	common	
3	common	
5	+V <sub>B</sub>	
7	common	
8	common	
9	output	



## **DESCRIPTION**

Hybrid amplifier module in a SOT115J package operating with a voltage supply of 24 V (DC). This high gain module consists of two cascaded stages, both in cascode configuration.

## **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Gp	power gain	f = 50 MHz	28.5	29.5	dB
		f = 860 MHz	29	-	dB
I <sub>tot</sub>	total current consumption (DC)	V <sub>B</sub> = 24 V	_	340	mA

## **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER		MAX.	UNIT
Vi	RF input voltage	_	55	dBmV
T <sub>stg</sub>	storage temperature	-40	+100	°C
$T_{mb}$	operating mounting base temperature	-20	+100	°C

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#### **CHARACTERISTICS**

**Table 1** Bandwidth 40 to 860 MHz;  $V_B = 24 \text{ V}$ ;  $T_{mb} = 30 \,^{\circ}\text{C}$ ;  $Z_S = Z_L = 75 \,^{\circ}\Omega$ 

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Gp	power gain	f = 50 MHz	28.5	29.5	dB
		f = 860 MHz	29	_	dB
SL	slope cable equivalent	f = 40 to 860 MHz	0.5	2.5	dB
FL	flatness of frequency response	f = 40 to 860 MHz	_	±0.5	dB
S <sub>11</sub>	input return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	18.5	_	dB
		f = 160 to 320 MHz	17	_	dB
		f = 320 to 640 MHz	15.5	_	dB
		f = 640 to 860 MHz	14	_	dB
S <sub>22</sub>	output return losses	f = 40 to 80 MHz	20	-	dB
		f = 80 to 160 MHz	18.5	_	dB
		f = 160 to 320 MHz	17	_	dB
		f = 320 to 640 MHz	15.5	_	dB
		f = 640 to 860 MHz	14	_	dB
СТВ	composite triple beat	49 channels flat; V <sub>o</sub> = 44 dBmV; measured at 859.25 MHz	_	-60	dB
X <sub>mod</sub>	cross modulation	49 channels flat; V <sub>o</sub> = 44 dBmV; measured at 55.25 MHz	_	-60	dB
CSO	composite second order distortion	49 channels flat; V <sub>o</sub> = 44 dBmV; measured at 860.5 MHz	_	-60	dB
d <sub>2</sub>	second order distortion	note 1	_	-70	dB
Vo	output voltage	d <sub>im</sub> = -60 dB; note 2	58.5	_	dBmV
F	noise figure	f = 50 MHz	_	5	dB
		f = 550 MHz	_	5.5	dB
		f = 600 MHz	_	5.5	dB
		f = 650 MHz	_	5.5	dB
		f = 750 MHz	_	6	dB
		f = 860 MHz	_	6.5	dB
I <sub>tot</sub>	total current consumption (DC)	note 3	_	340	mA

## **Notes**

```
1. f_p = 55.25 MHz; V_p = 44 dBmV; f_q = 805.25 MHz; V_q = 44 dBmV; measured at f_p + f_q = 860.5 MHz.
```

2. Measured according to DIN45004B:

```
\begin{aligned} &f_p = 851.25 \text{ MHz; } V_p = V_o; \\ &f_q = 858.25 \text{ MHz; } V_q = V_o - 6 \text{ dB;} \\ &f_r = 860.25 \text{ MHz; } V_r = V_o - 6 \text{ dB;} \\ &\text{measured at } f_p + f_q - f_r = 849.25 \text{ MHz.} \end{aligned}
```

3. The module normally operates at  $V_B$  = 24 V, but is able to withstand supply transients up to 30 V.

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**Table 2** Bandwidth 40 to 860 MHz;  $V_B = 24$  V;  $T_{mb} = 30$  °C;  $Z_S = Z_L = 75$   $\Omega$ 

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Gp	power gain	f = 50 MHz	28.5	29.5	dB
		f = 860 MHz	29	_	dB
SL	slope cable equivalent	f = 40 to 860 MHz	0.5	2.5	dB
FL	flatness of frequency response	f = 40 to 860 MHz	_	±0.5	dB
S <sub>11</sub>	input return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	18.5	_	dB
		f = 160 to 320 MHz	17	_	dB
		f = 320 to 640 MHz	15.5	_	dB
		f = 640 to 860 MHz	14	_	dB
S <sub>22</sub>	output return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	18.5	_	dB
		f = 160 to 320 MHz	17	_	dB
		f = 320 to 640 MHz	15.5	_	dB
		f = 640 to 860 MHz	14	_	dB
СТВ	composite triple beat	129 channels flat; V <sub>o</sub> = 44 dBmV; measured at 859.25 MHz	_	-46	dB
X <sub>mod</sub>	cross modulation	129 channels flat; V <sub>o</sub> = 44 dBmV; measured at 55.25 MHz	-	-52	dB
CSO	composite second order distortion	129 channels flat; V <sub>o</sub> = 44 dBmV; measured at 860.5 MHz	-	-53	dB
d <sub>2</sub>	second order distortion	note 1	_	-70	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$ ; note 2	58.5	_	dBmV
F	noise figure	see Table 1	-	_	dB
I <sub>tot</sub>	total current consumption (DC)	note 3	-	340	mA

## **Notes**

```
1. f_p = 55.25 \text{ MHz}; V_p = 44 \text{ dBmV};

f_q = 805.25 \text{ MHz}; V_q = 44 \text{ dBmV};

measured at f_p + f_q = 860.5 \text{ MHz}.
```

2. Measured according to DIN45004B:

```
\begin{split} f_p &= 851.25 \text{ MHz; } V_p = V_o; \\ f_q &= 858.25 \text{ MHz; } V_q = V_o - 6 \text{ dB;} \\ f_r &= 860.25 \text{ MHz; } V_r = V_o - 6 \text{ dB;} \\ \text{measured at } f_p + f_q - f_r = 849.25 \text{ MHz.} \end{split}
```

3. The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.

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**Table 3** Bandwidth 40 to 750 MHz;  $V_B = 24$  V;  $T_{mb} = 30$  °C;  $Z_S = Z_L = 75$   $\Omega$ 

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Gp	power gain	f = 50 MHz	28.5	29.5	dB
		f = 750 MHz	29	_	dB
SL	slope cable equivalent	f = 40 to 750 MHz	0.2	2.2	dB
FL	flatness of frequency response	f = 40 to 750 MHz	_	±0.45	dB
S <sub>11</sub>	input return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	18.5	_	dB
		f = 160 to 320 MHz	17	_	dB
		f = 320 to 640 MHz	15.5	_	dB
		f = 640 to 750 MHz	14	_	dB
S <sub>22</sub>	output return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	18.5	_	dB
		f = 160 to 320 MHz	17	_	dB
		f = 320 to 640 MHz	15.5	_	dB
		f = 640 to 750 MHz	14	_	dB
СТВ	composite triple beat	110 channels flat; V <sub>o</sub> = 44 dBmV; measured at 745.25 MHz	_	-50	dB
X <sub>mod</sub>	cross modulation	110 channels flat; V <sub>o</sub> = 44 dBmV; measured at 55.25 MHz	-	-54	dB
CSO	composite second order distortion	110 channels flat; V <sub>o</sub> = 44 dBmV; measured at 746.5 MHz	-	-56	dB
d <sub>2</sub>	second order distortion	note 1	-	-70	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$ ; note 2	59	-	dBmV
F	noise figure	see Table 1	_	_	dB
I <sub>tot</sub>	total current consumption (DC)	note 3	-	340	mA

## **Notes**

```
1. f_p = 55.25 MHz; V_p = 44 dBmV; f_q = 691.25 MHz; V_q = 44 dBmV; measured at f_p + f_q = 746.5 MHz.
```

2. Measured according to DIN45004B:

$$\begin{split} f_p &= 740.25 \text{ MHz; } V_p = V_o; \\ f_q &= 747.25 \text{ MHz; } V_q = V_o - 6 \text{ dB;} \\ f_r &= 749.25 \text{ MHz; } V_r = V_o - 6 \text{ dB;} \\ \text{measured at } f_p + f_q - f_r = 738.25 \text{ MHz.} \end{split}$$

3. The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.

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**Table 4** Bandwidth 40 to 600 MHz;  $V_B = 24$  V;  $T_{mb} = 30$  °C;  $Z_S = Z_L = 75$   $\Omega$ 

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Gp	power gain	f = 50 MHz	28.5	29.5	dB
		f = 600 MHz	29	_	dB
SL	slope cable equivalent	f = 40 to 600 MHz	_	2	dB
FL	flatness of frequency response	f = 40 to 600 MHz	_	±0.35	dB
S <sub>11</sub>	input return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	18.5	_	dB
		f = 160 to 320 MHz	17	_	dB
		f = 320 to 600 MHz	16	_	dB
S <sub>22</sub>	output return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	18.5	-	dB
		f = 160 to 320 MHz	17	_	dB
		f = 320 to 600 MHz	16	-	dB
СТВ	composite triple beat	85 channels flat; V <sub>o</sub> = 44 dBmV; measured at 595.25 MHz	-	-55	dB
X <sub>mod</sub>	cross modulation	85 channels flat; $V_0 = 44 \text{ dBmV}$ ; measured at 55.25 MHz	-	-56	dB
CSO	composite second order distortion	85 channels flat; $V_0 = 44 \text{ dBmV}$ ; measured at 596.5 MHz	-	-60	dB
d <sub>2</sub>	second order distortion	note 1	_	-72	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$ ; note 2	61	_	dBmV
F	noise figure	see Table 1	_	_	dB
I <sub>tot</sub>	total current consumption (DC)	note 3	_	340	mA

#### **Notes**

```
 \begin{array}{ll} \text{1.} & f_p = 55.25 \text{ MHz}; \ V_p = 44 \ dBmV; \\ & f_q = 541.25 \ MHz; \ V_q = 44 \ dBmV; \\ & \text{measured at } f_p + f_q = 596.5 \ MHz. \end{array}
```

2. Measured according to DIN45004B:

```
\begin{aligned} &f_p = 590.25 \text{ MHz; } V_p = V_o; \\ &f_q = 597.25 \text{ MHz; } V_q = V_o - 6 \text{ dB;} \\ &f_r = 599.25 \text{ MHz; } V_r = V_o - 6 \text{ dB;} \\ &\text{measured at } f_p + f_q - f_r = 588.25 \text{ MHz.} \end{aligned}
```

3. The module normally operates at  $V_B$  = 24 V, but is able to withstand supply transients up to 30 V.

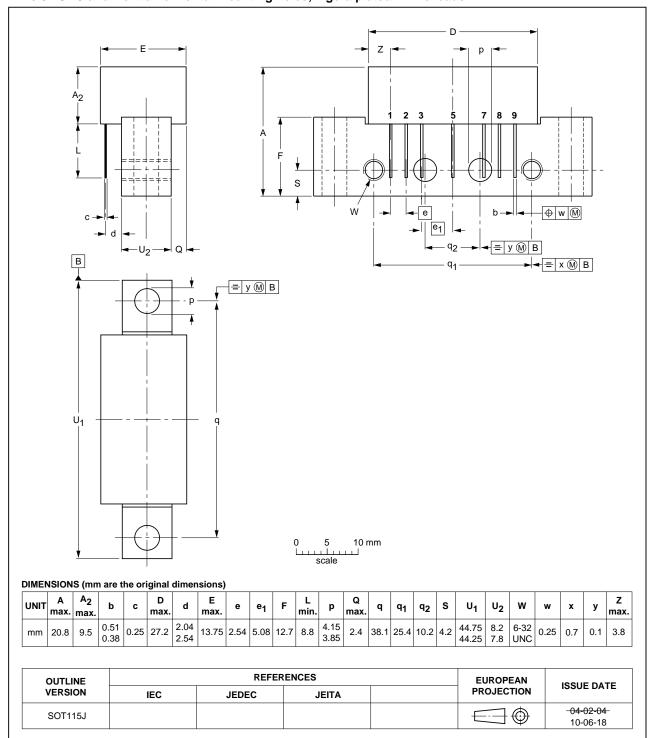
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#### **PACKAGE OUTLINE**

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J



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DOCUMENT STATUS(1)	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
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